A low cost solution for tape ring wafer mounting

Designed to offer a cost effective and highly efficient alternative to automated ring closing systems.

The Loadpoint PRESSPOINT is the most versatile and efficient manual closing and post dicing stretch system available, requires no power and is usable straight from the box.
Loadpoint have been continuously developing dicing systems for over 40 years. Our customers trust Loadpoint to help them develop class-leading products. We have helped many customers develop task orientated solutions for ultrasound scanners, inkjet printers, SAW filters, MEMS devices and a whole range of silicon based products.

**Loadpoint Expertise**

- Handles 94mm, 115mm, 140mm, 170mm, 195mm and 225mm tape rings with interchangeable standard tools (special available to order)
- Compatible with all types of foil or tape used for wafer mounting
- One operation to apply tape to rings
- All aluminium construction with a durable powder-coated paint finish and bearing bushes on all moving parts – built for reliability in a busy manufacturing environment
- Tape rolls easily and safely loaded, dispensed and unloaded
- Extremely cost effective with no service costs
- Simple to use, minimum effort required
- Post dicing stretch of cut substrate is easily achieved to protect finished components in transit

**Micromachining solutions for:**

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<th>SEMICONDUCTORS</th>
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<tbody>
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<td>ELECTRONICS</td>
<td>MEDICAL</td>
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Presspoint